# IGBT - Field Stop, Trench 650 V, 75 A

# FGH75T65SHDTL4

#### Description

Using novel field stop IGBT technology, ON Semiconductor's new series of field stop 3<sup>rd</sup> generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.

#### Features

- Maximum Junction Temperature: T<sub>J</sub> =175°C
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage:  $V_{CE(sat)} = 1.6 \text{ V} (Typ.) @ I_C = 75 \text{ A}$
- 100% of the Parts Tested for  $I_{LM}$
- High Input Impedance
- Fast Switching
- Tighten Parameter Distribution
- This Device is Pb-Free and is RoHS Compliant
- Do Not Recommend for Reflow and Full PKG Dipping

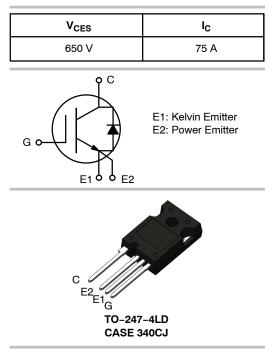
#### Applications

• Solar Inverter, UPS, Welder, Telecom, ESS, PFC

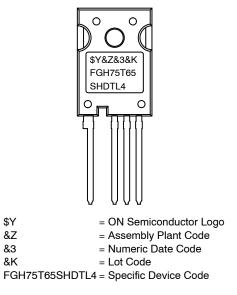


## **ON Semiconductor®**

#### www.onsemi.com



#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Description		FGH75T65SHDTL4	Unit
V <sub>CES</sub>	Collector to Emitter Voltage		650	V
V <sub>GES</sub>	Gate to Emitter Voltage		±20	V
	Transient Gate to Emitter Voltage		±30	V
Ι <sub>C</sub>	Collector Current T <sub>C</sub>	= 25°C	150	А
	T <sub>C</sub>	= 100°C	75	А
I <sub>LM</sub> (Note 1)	Pulsed Collector Current T <sub>C</sub>	= 25°C	300	А
I <sub>CM</sub> (Note 2)	Pulsed Collector Current		300	А
١ <sub>F</sub>	Diode Forward Current T <sub>C</sub>	= 25°C	125	А
	Diode Forward Current T <sub>C</sub>	= 100°C	75	А
I <sub>FM</sub> (Note 2)	Pulsed Diode Maximum Forward Current		300	А
PD	Maximum Power Dissipation T <sub>C</sub>	= 25°C	455	W
	T <sub>C</sub>	= 100°C	227	W
TJ	Operating Junction Temperature		–55 to +175	°C
T <sub>STG</sub>	Storage Temperature Range		–55 to +175	°C
ΤL	Maximum Lead Temp. for Soldering Purposes, 1/8"	from Case for 5 Seconds	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
V<sub>CC</sub> = 400 V, V<sub>GE</sub> = 15 V, I<sub>C</sub> = 300 A, R<sub>G</sub> = 73 Ω, Inductive Load.
Repetitive rating: Pulse width limited by max. junction temperature.

#### **THERMAL CHARACTERISTICS**

Symbol	Parameter	FGH75T65SHDTL4	Unit
R <sub>θJC</sub> (IGBT)	Thermal Resistance, Junction to Case, Max.	0.33	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case, Max.	0.65	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH75T65SHDTL4	FGH75T65SHDTL4	TO-247-4LD	Tube	-	-	30

#### ELECTRICAL CHARACTERISTICS OF THE IGBT (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit			
OFF CHARAC	FF CHARACTERISTICS								
BV <sub>CES</sub>	Collector to Emitter Breakdown Voltage	V <sub>GE</sub> = 0 V, I <sub>C</sub> = 1 mA	650	-	-	V			
${\Delta{\rm BV}_{\rm CES}/\over \Delta{\rm T_J}}$	Temperature Coefficient of Breakdown Voltage	$I_{C} = 1 \text{ mA}$ , Reference to 25°C	-	0.65	_	V/°C			
I <sub>CES</sub>	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA			
I <sub>GES</sub>	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	I	-	±400	nA			
ON CHARACTERISTICS									
V <sub>GE(th)</sub>	G-E Threshold Voltage	$I_{C}$ = 75 mA, $V_{CE}$ = $V_{GE}$	4.0	5.5	7.5	V			

	V <sub>GE(th)</sub>	G-E Threshold Voltage	$I_C = 75 \text{ mA}, V_{CE} = V_{GE}$	4.0	5.5	7.5	V
ſ	V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage	I <sub>C</sub> = 75 A, V <sub>GE</sub> = 15 V	-	1.6	2.1	V
			I <sub>C</sub> = 75 A, V <sub>GE</sub> = 15 V, T <sub>C</sub> = 175°C	-	2.28	-	V

#### ELECTRICAL CHARACTERISTICS OF THE IGBT (T<sub>C</sub> = 25°C unless otherwise noted) (continued)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit		
DYNAMIC CHARACTERISTICS								
C <sub>ies</sub>	Input Capacitance	V <sub>CE</sub> = 30 V, V <sub>GE</sub> = 0 V, f = 1 MHz	-	3710	-	pF		
C <sub>oes</sub>	Output Capacitance	= 1  IVITIZ	-	183	-	pF		
C <sub>res</sub>	Reverse Transfer Capacitance		-	43	-	pF		

T <sub>d(on)</sub>	Turn-On Delay Time	V <sub>CC</sub> = 400 V, I <sub>C</sub> = 75 A, R <sub>G</sub> = 15 Ω, V <sub>GE</sub> = 15 V,	-	55	-	n
T <sub>r</sub>	Rise Time	Inductive Load, $T_C = 25^{\circ}C$	-	50	-	n
T <sub>d(off)</sub>	Turn-Off Delay Time		-	189	-	n
T <sub>f</sub>	Fall Time		-	39	-	n
Eon	Turn-On Switching Loss		-	1.06	-	m
E <sub>off</sub>	Turn-Off Switching Loss		-	1.56	-	m
E <sub>ts</sub>	Total Switching Loss		-	2.62	-	m
T <sub>d(on)</sub>	Turn-On Delay Time	$V_{CC} = 400 \text{ V}, I_C = 75 \text{ A},$	-	48	-	n
Tr	Rise Time	$\frac{1}{10000000000000000000000000000000000$	-	56	-	n
T <sub>d(off)</sub>	Turn-Off Delay Time		-	205	-	n
T <sub>f</sub>	Fall Time		-	40	-	n
Eon	Turn-On Switching Loss		-	2.34	-	m
E <sub>off</sub>	Turn-Off Switching Loss		-	1.81	-	m
E <sub>ts</sub>	Total Switching Loss		-	4.15	-	m
Qg	Total Gate Charge	V <sub>CE</sub> = 400 V, I <sub>C</sub> = 75 A, V <sub>GE</sub> = 15 V	-	126	-	n
Q <sub>ge</sub>	Gate to Emitter Charge	VGE = 13 V	-	24.1	-	n
Q <sub>gc</sub>	Gate to Collector Charge		-	47.6	-	n(

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### ELECTRICAL CHARACTERISTICS OF THE DIODE (T<sub>C</sub> = $25^{\circ}$ C unless otherwise noted)

Symbol	Parameter	Test Co	Test Conditions		Тур	Max	Unit
V <sub>FM</sub>	Diode Forward Voltage	I <sub>F</sub> = 75 A	$T_{C} = 25^{\circ}C$	-	1.8	2.1	V
			T <sub>C</sub> = 175°C	-	1.7	-	
E <sub>rec</sub>	Reverse Recovery Energy	I <sub>F</sub> = 75 A, dI <sub>F</sub> /dt = 200 A/μs	T <sub>C</sub> = 175°C	-	160	-	μJ
T <sub>rr</sub>	Diode Reverse Recovery Time	- αι <sub>F</sub> /αι - 200 Α/μο	$T_{\rm C} = 25^{\circ}{\rm C}$	-	76	-	ns
			T <sub>C</sub> = 175°C	-	270	-	
Q <sub>rr</sub>	Diode Reverse Recovery Charge		$T_{C} = 25^{\circ}C$	-	206	-	nC
			$T_{\rm C} = 175^{\circ}{\rm C}$	-	2199	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### **TYPICAL PERFORMANCE CHARACTERISTICS**

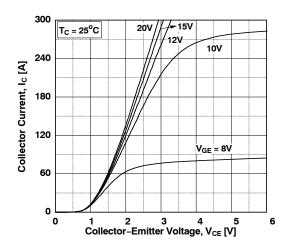


Figure 1. Typical Output Characteristics

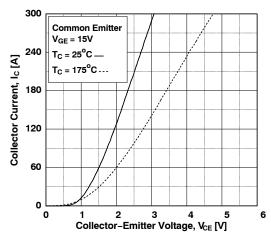


Figure 3. Typical Saturation Voltage Characteristics

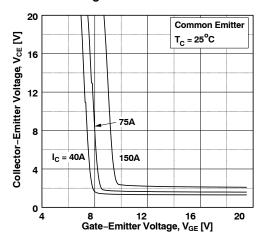


Figure 5. Saturation Voltage vs. V<sub>GE</sub>

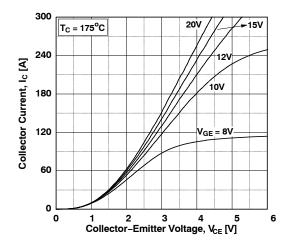


Figure 2. Typical Output Characteristics

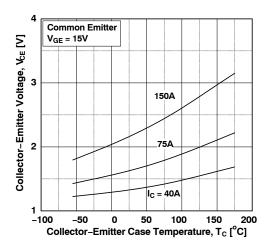


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

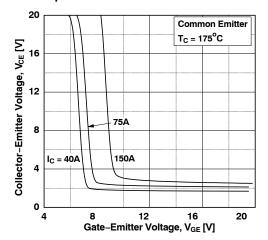
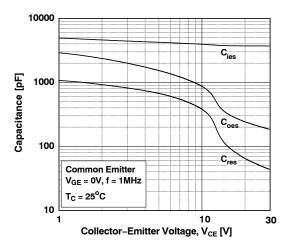
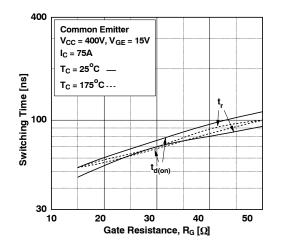


Figure 6. Saturation Voltage vs. V<sub>GE</sub>

#### TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



**Figure 7. Capacitance Characteristics** 





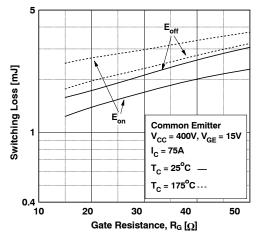


Figure 11. Switching Loss vs. Gate Resistance

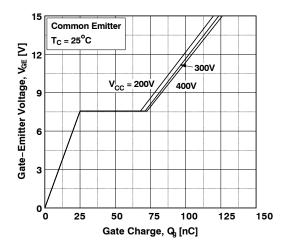


Figure 8. Gate Charge Characteristics

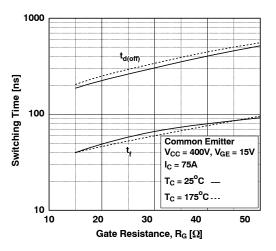


Figure 10. Turn-off Characteristics vs. Gate Resistance

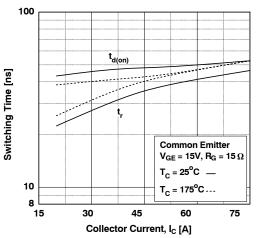
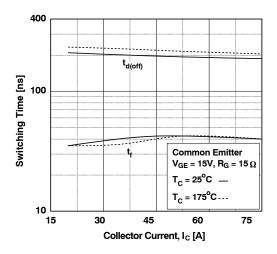


Figure 12. Turn-on Characteristics vs. Collector Current

#### TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





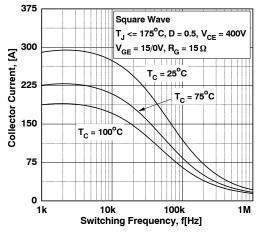


Figure 15. Load Current vs. Frequency

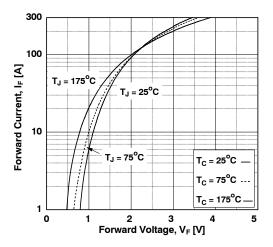


Figure 17. Forward Characteristics

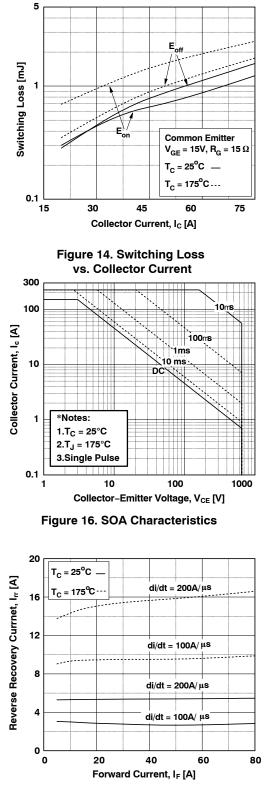


Figure 18. Reverse Recovery Current

#### TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

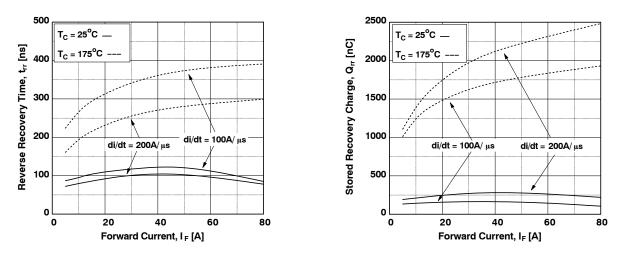


Figure 19. Reverse Recovery Time



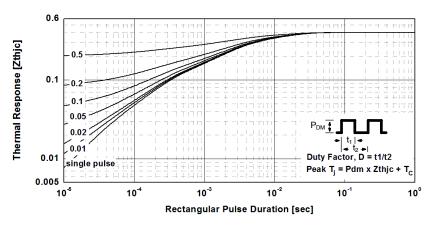


Figure 21. Transient Thermal Impedance of IGBT

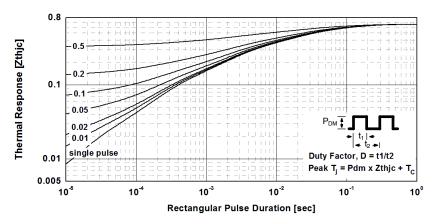
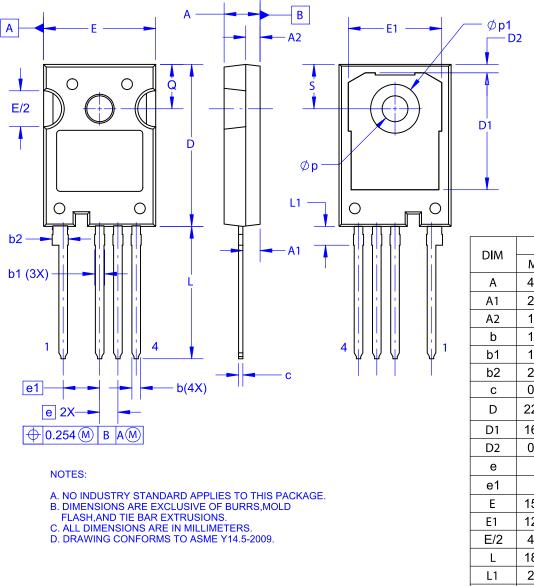


Figure 22. Transient Thermal Impedance of Diode



TO-247-4LD CASE 340CJ ISSUE A

DATE 16 SEP 2019



	MIL	LIMETER	S
DIM	MIN	NOM	MAX
А	4.80	5.00	5.20
A1	2.10	2.40	2.70
A2	1.80	2.00	2.20
b	1.07	1.20	1.33
b1	1.20	1.40	1.60
b2	2.02	2.22	2.42
С	0.50	0.60	0.70
D	22.34	22.54	22.74
D1	16.00	16.25	16.50
D2	0.97	1.17	1.37
е	2	2.54 BSC	2
e1	Ę	5.08 BSC	2
Е	15.40	15.60	15.80
E1	12.80	13.00	13.20
E/2	4.80	5.00	5.20
L	18.22	18.42	18.62
L1	2.42	2.62	2.82
р	3.40	3.60	3.80
p1	6.60	6.80	7.00
Q	5.97	6.17	6.37
S	5.97	6.17	6.37

DOCUMENT NUMBER:	98AON13852G	98AON13852G Electronic versions are uncontrolled except when accessed directly from the Document Re Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.				
DESCRIPTION:	TO-247-4LD		PAGE 1 OF 1			
ON Semiconductor and I are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries.						

ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and calcular performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

#### TECHNICAL SUPPORT

onsemi Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

onsemi: FGH75T65SHDTL4